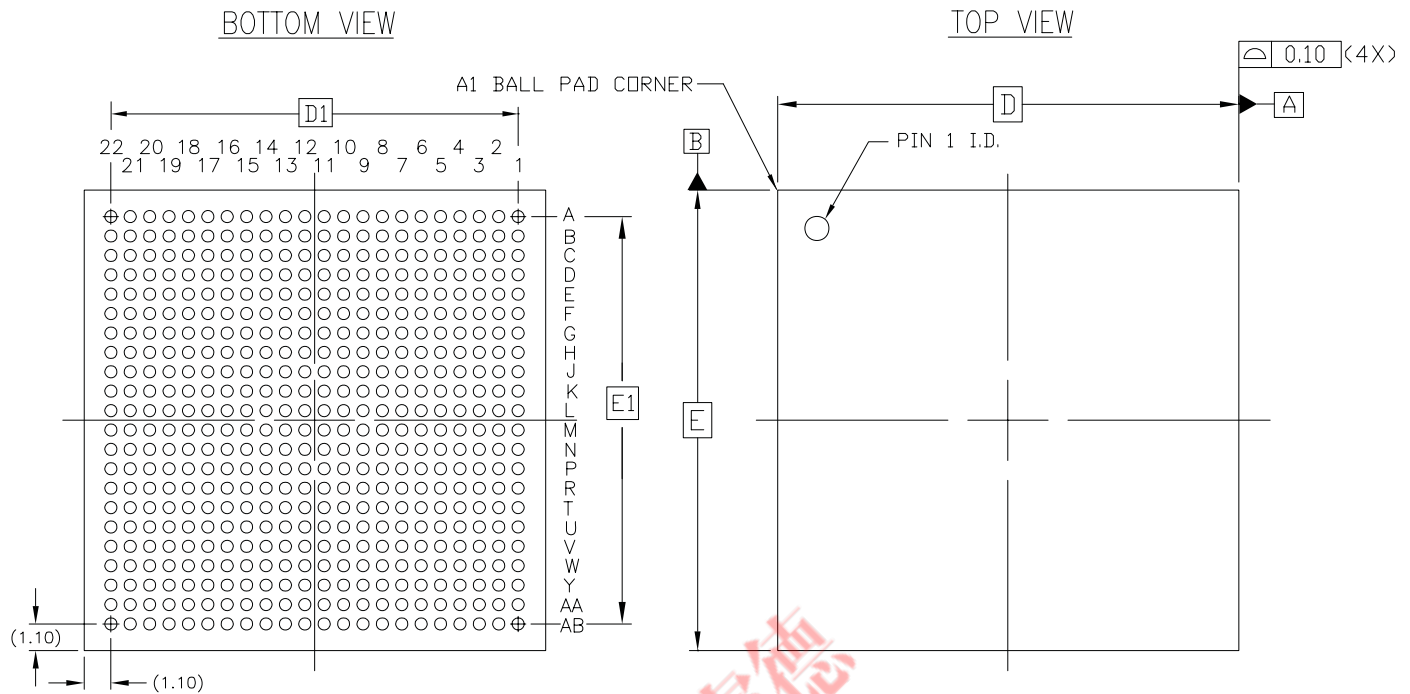




CS484 - 63/37 Sn/Pb SOLDER BALLS
CSG484 - Sn/Ag/Cu SOLDER BALLS

NOTES:

1. ALL DIMENSIONS AND TOLERANCES CONFORM TO ANSI Y14.5M-1994.
2. SYMBOL 'M' IS THE BALL MATRIX SIZE
3. NOMINAL "A" DIMENSION IS TYPICALLY 1.67 mm
4. CONFORMS TO JEDEC MO-205.

484-BALL LAMINATE CHIP SCALE BGA, 0.80mm PITCH (CS484/CSG484)

Revision History

The following table shows the revision history for this document.

Date	Version	Revision
4/2/07	1.0	Initial Xilinx release.

